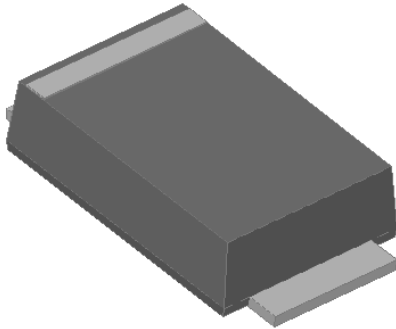


Surface Mount Fast Recovery Rectifier

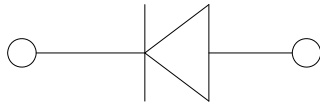


Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in high frequency rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.



Mechanical Data

- **Package:** SMAF
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

■ Maximum Ratings (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	F2AF	F2BF	F2DF	F2GF	F2JF	F2KF	F2MF
Device marking code			F2AF	F2BF	F2DF	F2GF	F2JF	F2KF	F2MF
Repetitive peak reverse voltage	VRRM	V	50	100	200	400	600	800	1000
Average rectified output current @60Hz sine wave, resistance load, TL (Fig.1)	I _O	A	2.0						
Surge(non-repetitive)forward current @60Hz half-sine wave,1 cycle, T _a =25°C	I _{FSM}	A	50						
Storage temperature	T _{stg}	°C	-55~+150						
Junction temperature	T _j	°C	-55~+150						

■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	F2AF	F2BF	F2DF	F2GF	F2JF	F2KF	F2MF
Maximum instantaneous forward voltage drop per diode	V _F	V	I _{FM} =2.0A	1.3						
Maximum reverse recovery time	t _r	ns	I _F =0.5A, I _R =1.0A, I _r =0.25A	150			250		500	
Maximum DC reverse current at rated DC blocking voltage per diode @ VRM=VRRM	IRRM	μA	T _a =25°C	5.0						
			T _a =125°C	100						



F2AF THRU F2MF

■ Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	F2AF	F2BF	F2DF	F2GF	F2JF	F2KF	F2MF
Typical Thermal resistance	R _{θJ-A} ⁽¹⁾	°C/W	65						
	R _{θJ-L} ⁽¹⁾		20						

Note:
 (1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

■ Characteristics (Typical)

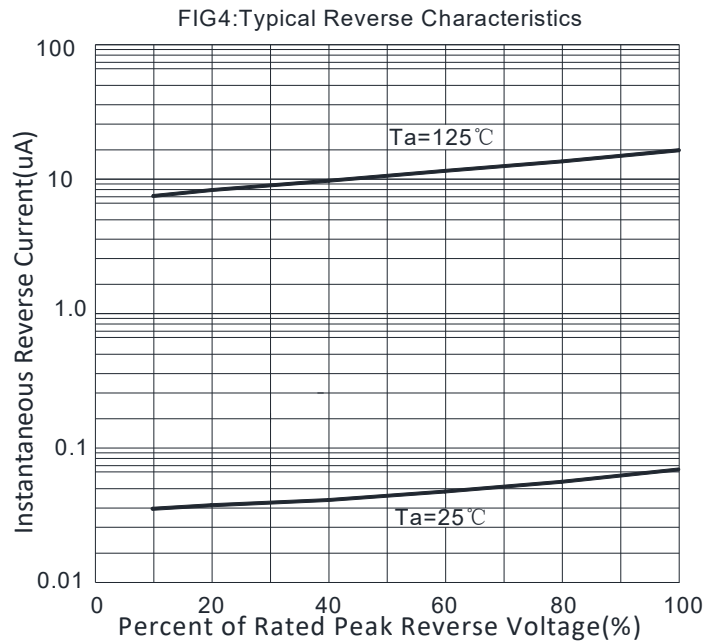
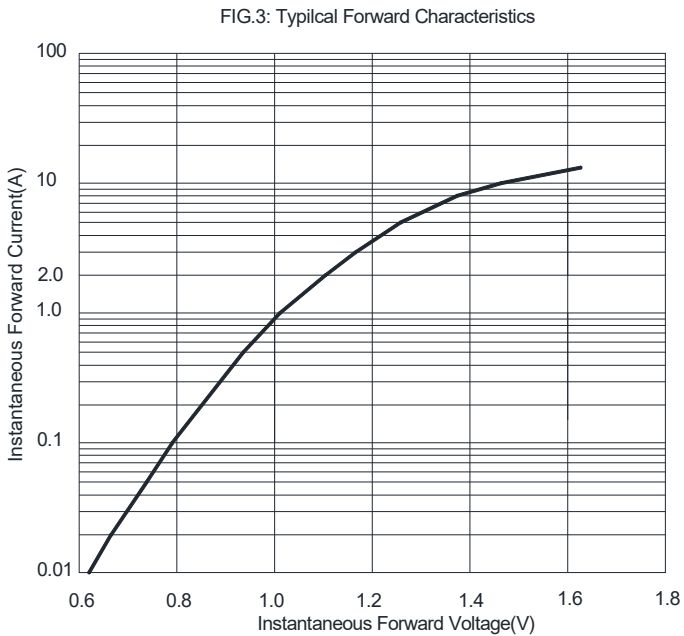
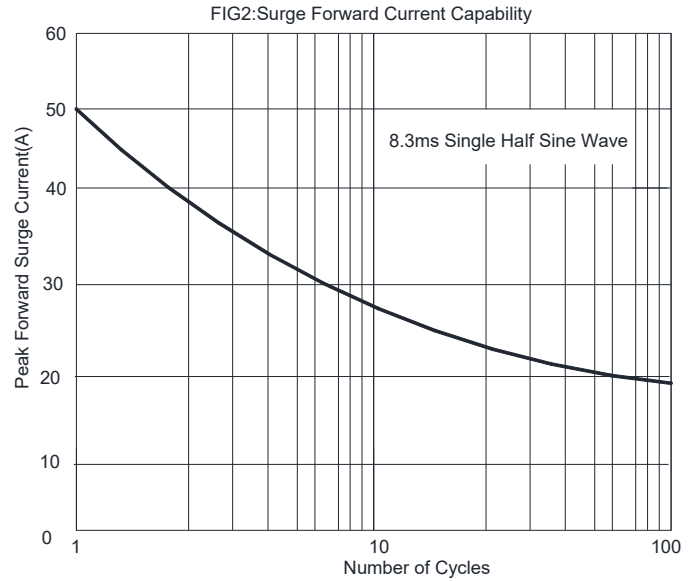
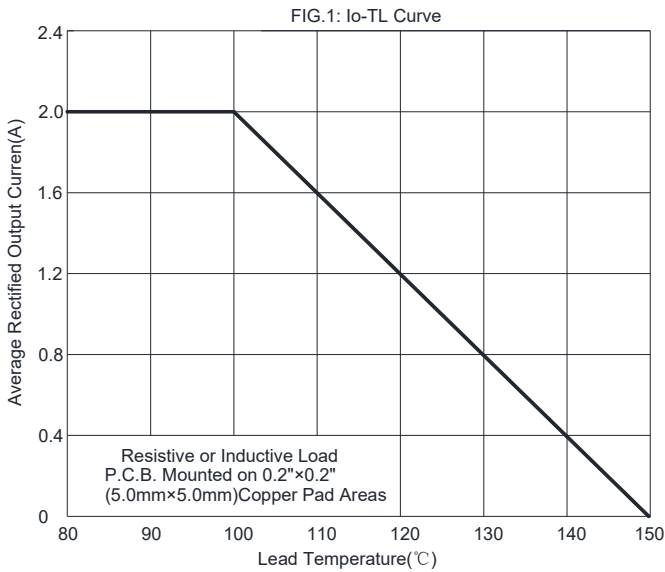
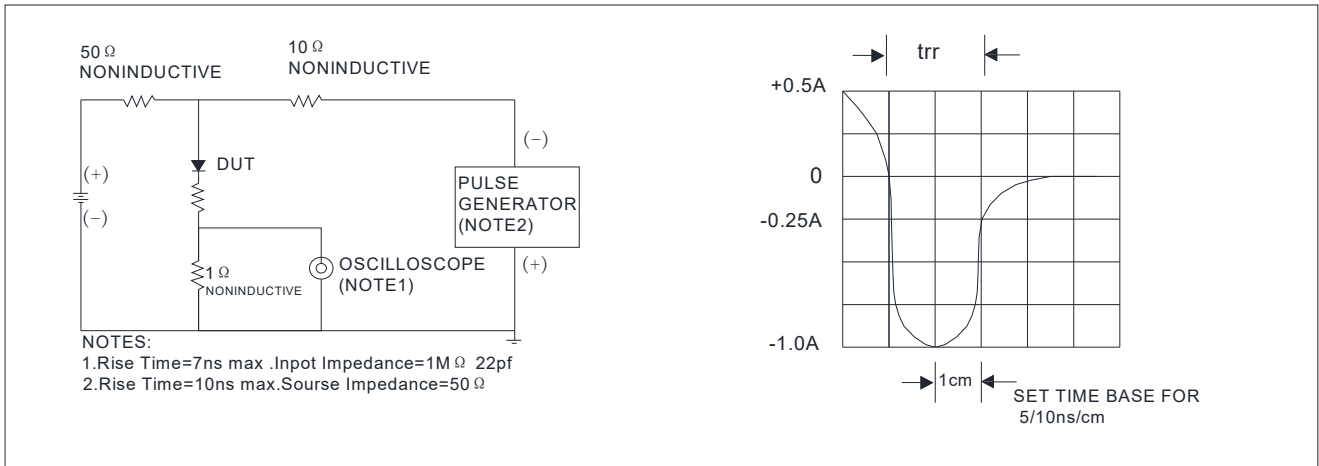


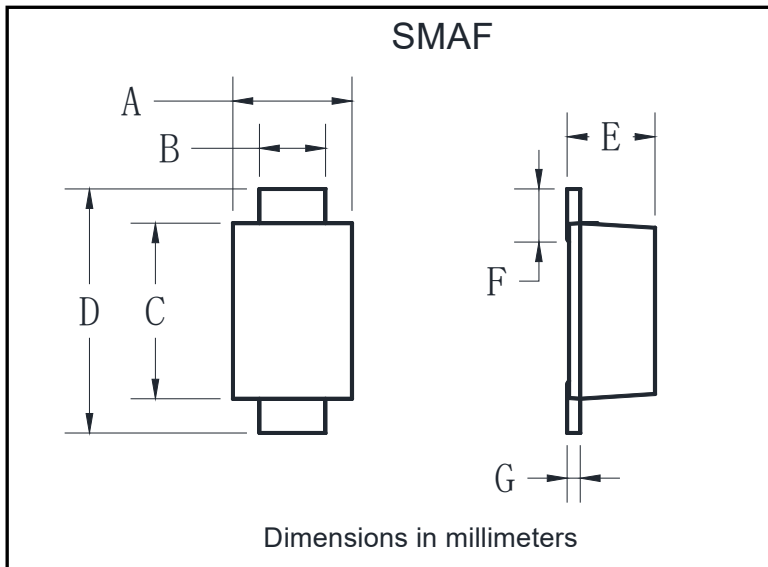
FIG.5: Diagram of circuit and Testing wave form of reverse recovery time



Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
F2AF-F2MF	F1	Approximate 0.034	3000	12000	96000	7" reel
F2AF-F2MF	F2	Approximate 0.034	10000	20000	160000	13" reel
F2AF-F2MF	F3	Approximate 0.034	10000	20000	120000	13" reel
F2AF-F2MF	F4	Approximate 0.034	7500	15000	120000	13" reel

Outline Dimensions

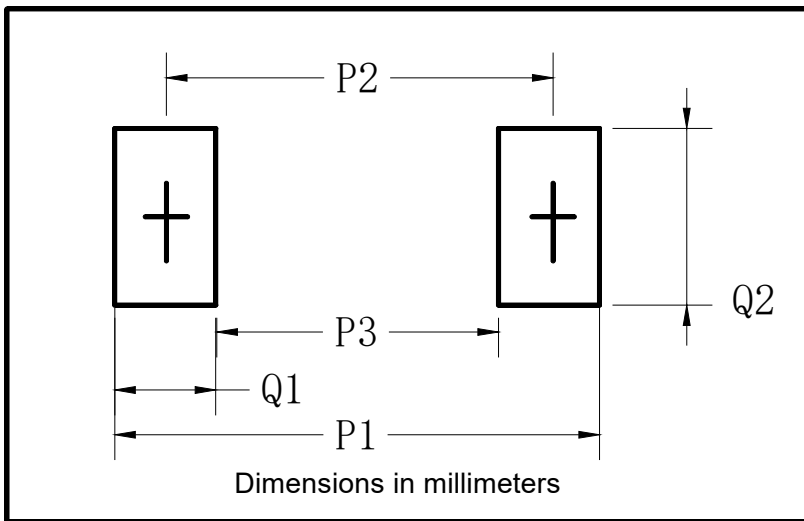


SMAF		
Dim	Min	Max
A	2.40	2.80
B	1.35	1.45
C	3.40	3.60
D	4.40	4.80
E	1.05	1.25
F	0.50	1.00
G	0.15	0.22



F2AF THRU F2MF

■ Suggested pad layout



SMAF	
Dim	Millimeters
P1	6.50
P2	4.00
P3	1.50
Q1	2.50
Q2	1.70



F2AF THRU F2MF

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